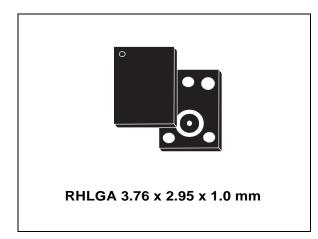
MP33AB01



MEMS audio surface-mount bottom-port silicon microphone with analog output

Datasheet - production data



Features

- Single supply voltage
- Low power consumption
- Omnidirectional sensitivity
- High signal-to-noise ratio
- · High bandwidth
- · Package compliant with reflow soldering

Description

The MP33AB01 is a compact, low-power microphone built with a low-profile sensing element.

The sensing element, capable of detecting acoustic waves, is manufactured using a specialized silicon micromachining process to produce audio sensors.

The MP33AB01 has an acoustic overload point of 125 dBSPL with a 63 dB signal-to-noise ratio.

The MP33AB01 is available in a package compliant with reflow soldering and is guaranteed to operate over an extended temperature range from -30 °C to +100 °C.

Table 1. Device summary

Order code	Temperature range [°C]	Package	Packing	
MP33AB01	-30 to +100	RHLGA (3.76 x 2.95 x 1.0) mm	Tray	
MP33AB01TR	-30 to +100	RHLGA (3.76 x 2.95 x 1.0) mm	Tape and reel	

Contents MP33AB01

Contents

1	Pin description	. 3
2	Acoustic and electrical specifications	. 4
	2.1 Acoustic and electrical characteristics	. 4
	2.2 Frequency response	. 5
3	Absolute maximum ratings	. 6
4	Application recommendations	. 7
5	Package mechanical data	. 8
6	Revision history	12



MP33AB01 Pin description

1 Pin description

Figure 1. Pin connections

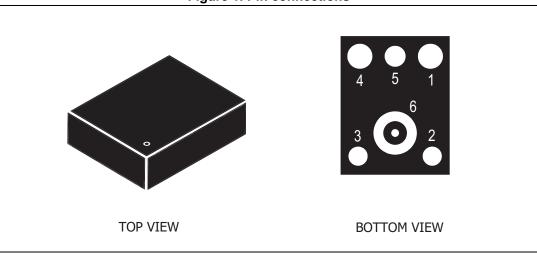


Table 2. Pin description

Pin #	Pin name	Function
1	Output	Analog output
2	GND	0 V supply
3	GND	0 V supply
4	Vdd	Power supply
5	GND	0 V supply
6	GND	0 V supply

2 Acoustic and electrical specifications

2.1 Acoustic and electrical characteristics

The values listed in the table below are specified for Vdd = 2.2 V unless otherwise noted.

Table 3. Acoustic and electrical characteristics

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
Vdd	Supply voltage		1.5	2.2	3.6	V
ldd	Current consumption	mean value = 2 V			0.25	mA
FR	Frequency range		100		10000	Hz
So	Sensitivity	at 1 kHz (0 dB = 1 V/Pa)	-41	-38	-35	dBV
SNR	Signal-to-noise ratio	at 1 kHz (0 dB = 1 V/Pa)		63		dB
Тор	Operating temperature range		-30		+100	°C

^{1.} Typical specifications are not guaranteed.

Table 4. Distortion specifications at 1 kHz

Parameter	Test condition	Value
Distortion	94 dBSPL	< 1% THD
Distortion	125 dBSPL	10% THD (typ.)

2.2 Frequency response

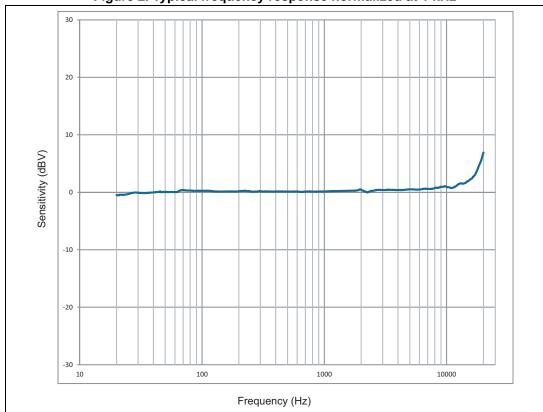


Figure 2. Typical frequency response normalized at 1 kHz



3 Absolute maximum ratings

Stresses above those listed as "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 5. Absolute maximum ratings

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.5 to 4	V
T _{STG}	Storage temperature range	-40 to +100	°C



This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.



This device is ESD-sensitive, improper handling can cause permanent damage to the part.

4 Application recommendations

Pigure 3. MP33AB01 electrical connections and external component values $\begin{array}{c}
Vdd \\
Pin.4 \\
MP33AB01
\end{array}$ $\begin{array}{c}
Pin.2,3,5,6 \\
Pin.2,3,5,6
\end{array}$ $\begin{array}{c}
C1 \\
Pin.2,3,5,6$

Figure 3. MP33AB01 electrical connections and external component values

The DC-blocking capacitor C1 is required on the Vout pin as shown in *Figure 3*. The C1 value and the input resistance of the interface circuit (R) affect the cut-off frequency of the Audio signal path as:

3 dB cut-off freq = $1/2\pi$ RC1

It's advisable to have a cut-off frequency well below 20 HZ, so for a typical input resistance of about 20 k Ω it is recommended to use a C1 > 1 μ F.



5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Soldering information

The RHLGA (3.76 x 2.95) mm package is also compliant with the RoHS and "Green" standards and is qualified for soldering heat resistance according to JEDEC J-STD-020.

Land pattern and soldering recommendations are available at www.st.com.

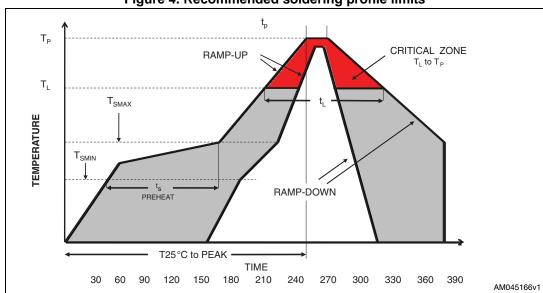


Figure 4. Recommended soldering profile limits

Table 6. Recommended soldering profile limits

Description	Parameter	Pb free
Average ramp rate	T _L to T _P	3 °C/sec max
Preheat		
Minimum temperature	T _{SMIN}	150 °C
Maximum temperature	T _{SMAX}	200 °C
Time (T _{SMIN} to T _{SMAX})	t _S	60 sec to 120 sec
Ramp-up rate	T_{SMAX} to T_{L}	
Time maintained above liquidous temperature	tL	60 sec to 150 sec
Liquidous temperature	T_L	217 °C
Peak temperature	T _P	260 °C max
Time within 5 °C of actual peak temperature		20 sec to 40 sec
Ramp-down rate		6 °C/sec max
Time 25 °C (t25 °C) to peak temperature		8 minutes max

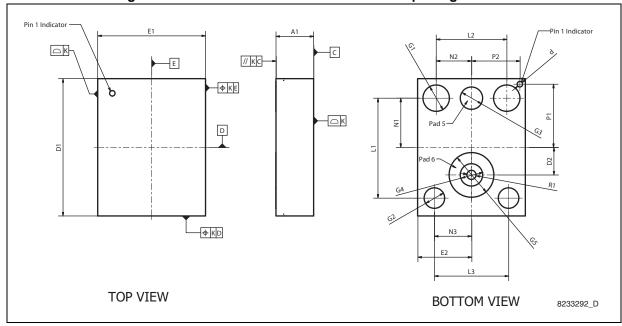


Figure 5. RHLGA 3.76 mm x 2.95 mm x 1.0 mm package outline

Table 7. RHLGA 3.76 mm x 2.95 mm x 1.0 mm package dimensions

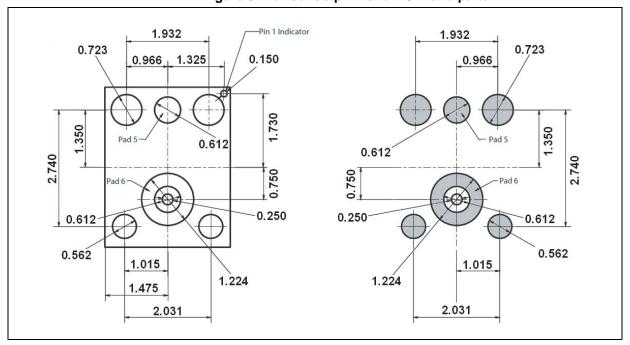
Symbol		mm			inch.	
Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.
A1	0.900	1.000	1.100	0.0354	0.0394	0.0433
D1	3.660	3.760	3.860	0.1441	0.1480	0.1520
D2	0.600	0.750	0.900	0.0236	0.0295	0.0354
R1	0.200	0.250	0.300	0.0079	0.0098	0.0118
E1	2.850	2.950	3.050	0.1122	0.1161	0.1201
E2	1.325	1.475	1.625	0.0522	0.0581	0.0640
L1	2.690	2.740	2.790	0.1059	0.1079	0.1098
L2	1.882	1.932	1.982	0.0741	0.0761	0.0780
L3	1.981	2.031	2.181	0.0780	0.0800	0.0859
N1	1.300	1.350	1.400	0.0512	0.0531	0.0551
N2	0.916	0.966	1.116	0.0361	0.0380	0.0440
N3	0.965	1.015	1.065	0.0380	0.0400	0.0419
G1	0.673	0.723	0.763	0.0265	0.0285	0.0300
G2	0.512	0.562	0.612	0.0202	0.0221	0.0241
G3	0.562	0.612	0.662	0.0221	0.0241	0.0261
G4	0.562	0.612	0.662	0.0221	0.0241	0.0261
G5	1.174	1.224	1.274	0.0462	0.0482	0.0502
P1	1.680	1.730	1.780	0.0661	0.0681	0.0701
P2	1.275	1.325	1.375	0.0502	0.0522	0.0541

577

Table 7. RHLGA 3.76 mm x 2.95 mm x 1.0 mm package dimensions (continued)

Symbol		mm			inch.	
Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.
d		0.150			0.0059	
K		0.050			0.0020	

Figure 6. Device footprint and PCB land pattern



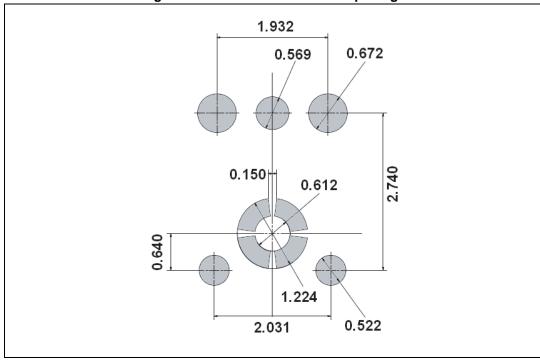


Figure 7. Recommended stencil openings



Revision history MP33AB01

6 Revision history

12/13

Table 8. Document revision history

Date	Revision	Changes
17-Jan-2013	1	Initial release
13-Sep-2013	2	Modified Figure 3 on page 7

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID24159 Rev 2

13/13

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MEMS Microphones category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

8103AC8333S25.00000X S-VM2020-C SPK0838HT4H-1 MMICT4076-00-908 MMICT4078-00-908 ICS-41352 1007079-1 ASFLM125.000MHZ-C 5000AC-8E-25E0-25.000000X ICS-40300 ICS-40618 ICS-43432 3807ACTC3-33EG-8.19200 501AAA27M0000CAF
SIT9120AC-2C2-25E125.000000 SIT9120AC-2C2-25E200.000000 SIT9121AI-2C3-33E100.000000 9120AI-2C3-25E100.00000
MP34DB01TR 8002AI-13-33E16.00000 5001AI-2D-18N0-20.000000 MM042602-4 MM042602-5 MM033802-1 ICS-43434 ASFLM228.224MHZ-LR-T ICS-40310 ICS-40720 9003AC-14-33EQ25.00000 SIT9120AC-2C2-33E125.000000 1618AA-13-33S-16.000000G PMM3738-VM1000-R 64-8801 IM69D120V01XTSA1 IM69D130V01XTSA1 SPA1687LR5H-1 SPG08P4HM4H-1 SPH0611LR5H-1
SPH0641LM4H-1 SPH0644LM4H-1 SPH0645LM4H-B SPH0690LM4H-1 SPH1642HT5H-1 SPH1668LM4H-1 SPH6611LR5H-1
SPK0415HM4H-B SPK0641HT4H-1 SPM0687LR5H-1 SPM1423HM4H-B SPQ1410HR5H-B